**URL** for Additional Information

PART INFORMATION

Mfg Item Number

Mfg Item Name

BSC9132NSN7KNKB

FCPBGA 780 23\*23 P0.8

SUPPLIER Company Name Freescale Semiconductor Inc Company Unique ID 14-141-7928 Response Date 2015-05-01 Response Document ID 008NK50008S295A1.4 Contact Name Freescale Semiconductor Inc Contact Title Product Technical Support **Contact Phone** 1-800-521-6274 Contact Email support@freescale.com **Authorized Representative** Daniel Binyon Representative Title **EPP Customer Response** Representative Phone 512-895-3406 Representative Email eppanlst@freescale.com

DECLARATION

EU RoHS
Pb Free
Yes
HalogenFree
Plating Indicator
EU RoHS Exemption(s)

www.freescale.com

MANUFACTURING Mfg Item Number BSC9132NSN7KNKB Mfg Item Name FCPBGA 780 23\*23 P0.8 Version ALL Weight 5.503800 UoM Unit Volume EACH J-STD-020 MSL Rating 3 Peak Processing Temperature 245 C Max Time at Peak Temperature 30 seconds Number of Processing Cycles 3

RoHS	
RoHS Directive	2011/65/EU
RoHS Definition	RoHS Definition: Quantity limit of 0.1% by mass (1000 PPM) of homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material of Cadmium
RoHS Legal Definition	Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part(s) identified on this form contains lead, mercury, cadmium, hexavalent chromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a RoHS restricted substance) in excess of the applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part(s), and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part(s), the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusive source of the Suppliers liability and the Companys remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Suppliers Standard Terms and Co
RoHS Declaration	1 - Item(s) do not contain RoHS restricted substances per the definition above
Supplier Acceptance	Accepted
Signature	Daniel Binyon
Exemption List Version	2012/51/EU
List of Freescale Accepted Exemptions	6(a) : Lead as an alloying element in steel for machining purposes and in galvanized steel containing up to 0.35% lead by weight
Zxompuono	6(b): Lead as an alloying element in aluminium containing up to 0.4% lead by weight
	6(c): Copper alloy containing up to 4% lead by weight
	7(a): Lead in high melting temperature type solders (i.e. lead-based alloys containing 85% by weight or more lead)
	7(b): Lead in solders for servers, storage and storage array systems, network infrastructure equipment for switching, signaling, transmission, and network management for telecommunications
	7(c)-I : Electrical and electronic components containing lead in a glass or ceramic other than dielectric ceramic in capacitors, e.g. piezoelectronic devices, or in a glass or ceramic matrix compound
	7(c)-II: Lead in dielectric ceramic in capacitors for a rated voltage of 125 V AC or 250 V DC or higher
	7(c)-III: Lead in dielectric ceramic in capacitors for a rated voltage of less than 125 V AC or 250 V DC
	7(c)-IV: Lead in PZT based dielectric ceramic materials for capacitors being part of integrated circuits or discrete semiconductors
	15: Lead in solders to complete a viable electrical connection between semiconductor die and carrier within integrated circuit flip chip packages

Declaration	0.5723 0.5087 0.1907 0.0112 0.0673 2.1617 50.5648 0.7977 14.6857 1.8357 3.6714 0.2039
Deciding Agent   Common address, and common	0.5087 0.1907 0.0112 0.0673 2.1617 50.5648 0.7977 14.6857 1.8357 3.6714 0.2039
Declaration	0.1907  0.0112  0.0673  2.1617  50.5648  0.7977  14.6857  1.8357  3.6714  0.2039
Select Palls - Lead Free	0.0112 0.0673 2.1617 50.5648 0.7977 14.6857 1.8357 3.6714 0.2039
Solider Flair - Lead Free   Mateirs   Mateirs   Solver, metal   Solver, meta	0.0673 2.1617 50.5648 0.7977 14.6857 1.8357 3.6714 0.2039
Solic Paul - Lead Free   Free   Medis   Medis   Solic Paul - Lead Free   Capper - Medis	0.0673 2.1617 50.5648 0.7977 14.6857 1.8357 3.6714 0.2039
December	2.1617 50.5648 0.7977 14.6857 1.8357 3.6714 0.2039
Pass Spreader   2,988	50.5648 0.7977 14.6857 1.8357 3.6714 0.2039
Figure   F	0.7977 14.6857 1.8357 3.6714 0.2039
Nexte   Spreader   Nexte   (external applications only)   Nexte   7440-02-0   0.0490088   0   150333   150333   150333   150333   150333   150333   150333   150333   150333	0.7977 14.6857 1.8357 3.6714 0.2039
De Encapoulant, Filler	14.6857 1.8357 3.6714 0.2039
De Encapoulant, Filler   Metals   Muninum, metal   7429-90-5   0.808272   g   72000   72   148857	1.8357 3.6714 0.2039
De Encapsulant, Filler   Solvents, additives, and other materials   Proprietary Material-Other alloxanes and silicones   1314-13-2   0.20088   0   10000   18   3571   3	1.8357 3.6714 0.2039
De Encapsulant, Filler   Metals   Zinc oxide   1314-13-2   0.02088   0 180000   18   36714	3.6714 0.2039
Die Encapsulant, Filler   Solvents, additives, and other materials   Proprietary Material-Other miscellaneous substances.   0.011226   g   10000   1   2039	0.2039
Underfill	
Underfil   Bismuth/Bismuth Compounds   Bismuth Initiate   10361-44-1   0.000134   9   5000   0.5   24	0.0024
Underfill   Bismuth Bismuth Compounds   Bismuth trioxide   1304-76-3   0.000134   g   5000   0.5   24	0.0024
Underfill   Plastics/polymers   1,6-Bist(2,3-epoxypropoxy) naphthalene   27610-48-6   0.00402   g   150000   15   730	
Underfill   Plastics/polymers   Phenolic Polymer Resin, Epikote 155   9003-36-5   0.00268   g   100000   10   486	0.0024
Underfill   Solvents, additives, and other materials   Carbon Black   1333-86-4   0.000134   g   5000   0.5   24	0.073
Underfill   Plastics/polymers   4,4'-Isopropylidenediphenol-1-chloro-2,3-epoxypropane   25086-38-6   0.000804   g   30000   3   146	0.0486
Concentrate	0.0024
Underfill         Solvents, additives, and other materials         Proprietary Material-Other miscellaneous substances.         -         0.000134         g         5000         0.5         24           Underfill         Solvents, additives, and other materials         Proprietary Material-Other aliphatic amine compounds         -         0.00268         g         10000         10         486           Organic Substrate, Halogen-fre         1.1226         Metals         Proprietary Material-Other aliminum compounds         -         0.00021442         g         191         0.0191         38           Organic Substrate, Halogen-fre         Metals         Barium sulfate         7727-43-7         0.00746192         g         6647         0.6647         1355           Organic Substrate, Halogen-fre         Metals         Copper, metal         7440-50-8         0.42622539         g         379677         37.9677         77442           Organic Substrate, Halogen-fre         Plastics/polymers         Epikote 862         28064-14-4         0.06181597         g         55065         5.5065         11231	0.0146
Underfill         Solvents, additives, and other materials         Proprietary Material-Other aliphatic amine compounds         -         0.00268         g         10000         10         486           Organic Substrate, Halogen-fre         1.1226         Froprietary Material-Other aluminum compounds         -         0.00021442         g         191         0.0191         38           Organic Substrate, Halogen-fre         Metals         Barium sulfate         7727-43-7         0.00746192         g         6647         0.6647         1355           Organic Substrate, Halogen-fre         Metals         Copper, metal         7440-50-8         0.42622539         g         379677         37.9677         77442           Organic Substrate, Halogen-fre         Plastics/polymers         Epikote 862         28064-14-4         0.06181597         g         55065         5.5065         11231	0.2921
Organic Substrate, Halogen-fre         1.1226         Metals         Proprietary Material-Other aluminum compounds         0.00021442         g         191         0.0191         38           Organic Substrate, Halogen-fre         Metals         Barium sulfate         7727-43-7         0.00746192         g         6647         0.6647         1355           Organic Substrate, Halogen-fre         Metals         Copper, metal         7440-50-8         0.42622539         g         379677         37.9677         77442           Organic Substrate, Halogen-fre         Plastics/polymers         Epikote 862         28064-14-4         0.06181597         g         55065         5.5065         11231	0.0024
Organic Substrate, Halogen-fre         Metals         Proprietary Material-Other aluminum compounds         -         0.00021442         g         191         0.0191         38           Organic Substrate, Halogen-fre         Metals         Barium sulfate         7727-43-7         0.00746192         g         6647         0.6647         1355           Organic Substrate, Halogen-fre         Metals         Copper, metal         7440-50-8         0.42622539         g         379677         37.9677         77442           Organic Substrate, Halogen-fre         Plastics/polymers         Epikote 862         28064-14-4         0.06181597         g         55065         5.5065         11231	0.0486
Organic Substrate, Halogen-fre         Metals         Barium sulfate         7727-43-7         0.00746192         g         6647         0.6647         1355           Organic Substrate, Halogen-fre         Metals         Copper, metal         7440-50-8         0.42622539         g         379677         37.9677         77442           Organic Substrate, Halogen-fre         Plastics/polymers         Epikote 862         28064-14-4         0.06181597         g         55065         5.5065         11231	
Organic Substrate, Halogen-fre         Metals         Copper, metal         7440-50-8         0.42622539         g         379677         37.9677         77442           Organic Substrate, Halogen-fre         Plastics/polymers         Epikote 862         28064-14-4         0.06181597         g         55065         5.5065         11231	0.0038
Organic Substrate, Halogen-fre         Plastics/polymers         Epikote 862         28064-14-4         0.06181597         g         55065         5.5065         11231	0.1355
	7.7442
Organic Substrate Halogen-fre Plastics/notymers Proprietary Material-Other Epoxy resins - 0.04182359 g 37256 37256 7599	1.1231
9 07200 1.02000 porjulate 1.0000 porjula	0.7599
Organic Substrate, Halogen-fre         Metals         Talc         14807-96-6         0.00085767         g         764         0.0764         155	0.0155
Organic Substrate, Halogen-fre Solvents, additives, and other materials Proprietary Material-Other organic phosphorous - 0.01286836 g 11463 1.1463 2338	0.2338
Organic Substrate, Halogen-fre Plastics/polymers 4,4'-Isopropylidenediphenol-1-chloro-2,3-epoxypropane concentrate 25068-38-6 0.01447705 g 12896 1.2896 2630	0.263
Organic Substrate, Halogen-fre Plastics/polymers Phenol, polymer with formaldehyde 9003-35-4 0.04945278 g 44052 4.4052 8985	0.8985
Organic Substrate, Halogen-fre Plastics/polymers Proprietary Material-Other polymers - 0.03073005 g 27374 2.7374 5583	0.5583
Organic Substrate, Halogen-fre         Glass         Fibrous-glass-wool         65997-17-3         0.23489844         g         209245         20,9245         42679	4.2679
Organic Substrate, Halogen-fre         Glass         Silicon dioxide         7631-86-9         0.150324         g         133907         13.3907         27312	2.7312
Organic Substrate, Halogen-fre         Metals         Silver, metal         7440-22-4         0.00051976         g         463         0.0463         94	0.0094
Organic Substrate, Halogen-fre         Metals         Tin, metal         7440-31-5         0.01670541         g         14881         1.4881         3035	0.3035
Organic Substrate, Halogen-fre         Metals         Aluminum Hydroxide         21645-51-2         0.07417804         g         66077         6.6077         13477	1.3477
Organic Substrate, Halogen-fre Metals Copper phthalocyanine 147-14-8 0.0004715 g 42 0.0042 8	0.0008
Pb-free Bumped Semiconductor D 0.2117 g g g	
Pb-free Bumped Semiconductor D Nickel (external applications only) Nickel 7440-02-0 0.0010585 g 5000 0.5 192	
Pb-free Bumped Semiconductor D Metals Silver, metal 7440-22-4 0.00066886 g 3150 0.315 121	0.0192
Pb-free Bumped Semiconductor D Metals Tin, metal 7440-31-5 0.01838615 g 86850 8.685 3340	0.0192 0.0121
Pb-free Bumped Semiconductor D Solvents, additives, and other materials Other miscellaneous substances (less than 5%) 0,0019053 g 9000 0.9 346	
Pb-free Bumped Semiconductor D Glass Silicon, doped - 0.18968319 g 896000 89.6 34464	0.0121

LINKS

MCD LINK

http://www.freescale.com Freescale website

GENERAL ENVIRONMENTAL COMPLIANCE LINKS

http://www.freescale.com/files/abstract/corporate/ehs\_epp/ENV\_ROHS\_Freescale\_Response.pdf RoHS signed letter China RoHS http://www.freescale.com/chinarohs

REACH signed letter  $http://www.freescale.com/files/abstract/corporate/ehs\_epp/ENV\_REACH\_Freescale\_Response.pdf$ 

ELV signed letter http://www.freescale.com/files/abstract/corporate/ehs\_epp/ENV\_ELV\_Freescale\_Reponse.pdf **Conflict Minerals statement**  $http://www.freescale.com/files/abstract/corporate/ehs\_epp/ENV\_CONFLICT\_METAL\_Freescale\_Response.pdf$ 

FREESCALE ENVIRONMENTAL INFORMATION

EPP website http://www.freescale.com/epp

FAQ http://www.freescale.com/webapp/sps/site/overview.jsp?code=ENVIRON\_FAQ

Technical Service Request

LINKS TO BLANK IPC1752 FORMS

https://www.freescale.com/webapp/servicerequest.create\_SR.framework?defaultCategory=Hardware Product Support&defaultTopic=Environmentally Preferred Prod

Blank IPC1752 v1.1 Form http://www.freescale.com/files/abstract/corporate/ehs\_epp/IPC-1752-2\_v1.1\_MCD\_Template.pdf

## IPC1752 XML LINKS

http://www.freescale.com/mcds/BSC9132NSN7KNKB\_IPC1752\_v11.xml

http://www.freescale.com/mcds/BSC9132NSN7KNKB\_IPC1752A.xml